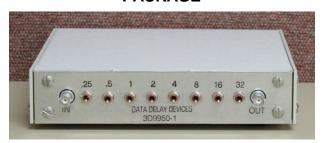
8-BIT ADJUSTABLE, COAXIAL **PASSIVE DELAY LINE** (SERIES 3D9950)



FEATURES

- Delay adjustable in 255 steps
- Delay step sizes of 0.25ns to 1ns available
- Fast rise time for high frequency applications
- I/O reversible
- **BNC** female connectors
- Meets or exceeds MIL-D-23859C

PACKAGE



OUT

FUNCTIONAL DESCRIPTION

The 3D9950 device is a single-input, single-output, passive delay line. The signal input (IN) is reproduced at the output (OUT), shifted by a time (T_D) which can be adjusted via eight binary-weighted switches. The value of these switches, multiplied by the device dash number, determines the

PIN DESCRIPTIONS

Signal Input (BNC) Signal Output (BNC)

device delay (referenced to the delay with all the switches off). The device is offered in 50-ohm and 75-ohm impedance versions.

SERIES SPECIFICATIONS

Delay Tolerance: 2%

Minimum Delay

(all switches off): 2.5ns

Impedance: 50Ω or 75Ω Ripple in pass-band: Approx. 0.2dB Dielectric breakdown: 100 VDC

Operating temp: -65°C to +125°C Temperature coeff: <100 PPM/°C

Case dimensions: 8.5" W x 8.0" D x 2.0" H (21.6cm x 20.3cm x 5.1cm)

Part Number	Delay Step (ns)	Delay Range (ns)	Imped- ance (Ω)	3dB B.W. (MHz)
3D9950-0.25A	0.25	63.75	50	125
3D9950-0.5A	0.5	127.5	50	125
3D9950-1A	1.0	255.0	50	125
3D9950-0.25Y	0.25	63.75	75	125
3D9950-0.5Y	0.5	127.5	75	125
3D9950-1Y	1.0	255.0	75	125

DASH NUMBER SPECIFICATIONS

Notes: 3dB BW measured at maximum delay Other dash numbers available on request

©2016 Data Delay Devices

PASSIVE DELAY LINE TEST SPECIFICATIONS

TEST CONDITIONS

INPUT: OUTPUT:

Ambient Temperature: $25^{\circ}\text{C} \pm 3^{\circ}\text{C}$ R_{load}: $10\text{M}\Omega$ Input Pulse: High = +0.5V typical C_{load}: 10pf

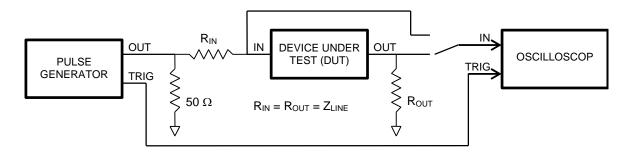
Low = -0.5V typical **Threshold:** 50% (Rising & Falling)

Source Impedance: 50Ω Max.

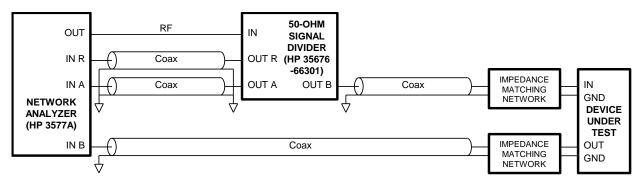
Rise/Fall Time: 3.0 ns Max. (measured at 10% and 90% levels)

Pulse Width: $PW_{IN} = 100 ns$ Period: $PER_{IN} = 1000 ns$

NOTE: The above conditions are for test only and do not in any way restrict the operation of the device.



Test Setup (Delay Measurements)



Test Setup (Frequency Response)